



P-Channel 30-V (D-S) MOSFET

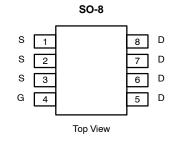
PRODUCT SUMMARY					
V _{DS} (V)	$r_{DS(on)}\left(\Omega\right)$	I _D (A)			
-30	0.014 @ V _{GS} = -10 V	-11			
	0.023 @ V _{GS} = -4.5 V	-8.5			

FEATURES

TrenchFET® Power MOSFET

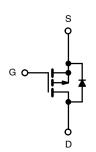


Pb-free Available



Ordering Information: Si4425DY

Si4425DY-T1 (with Tape and Reel) Si4425DY-E3 (Lead (Pb)-Free) Si4425DY-T1-E3 (Lead (Pb)-Free with Tape and Reel)



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (TA = 25°C UNLESS OTHERWISE NOTED)						
Parameter		Symbol	10 secs	Steady State	Unit	
Drain-Source Voltage		V _{DS}	-30			
Gate-Source Voltage		V _{GS}	±20		V	
Continuous Drain Current (T, I = 150°C) ^a	T _A = 25°C	ID	-11	-8		
Continuous Brain Garrent (1) = 150 G)	T _A = 70°C	- ' ^D	-8.7	-6.5	Α	
Pulsed Drain Current		I _{DM}	-50		,	
continuous Source Current (Diode Conduction) ^a		Is	-2.7	-1.36		
Maximum Power Dissipation ^a	T _A = 25°C	В	3.0	1.5		
	T _A = 70°C	- P _D	1.9	0.95	W	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to 150		°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
	t ≤ 10 sec	R _{thJA}	33	42		
Maximum Junction-to-Ambient ^a	Steady State		70	84	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	16	21		

Notes

a. Surface Mounted on 1" x 1" FR4 Board.

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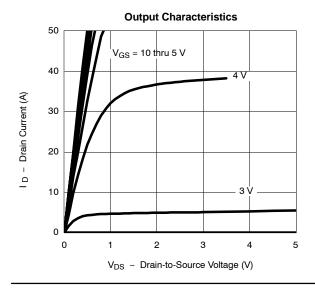


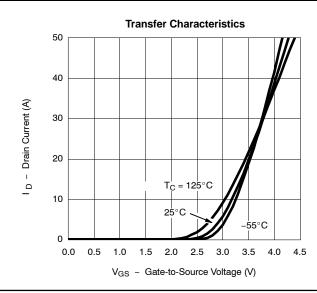
SPECIFICATIONS (T _J = 25°C UNLESS OTHERWISE NOTED)							
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit	
Static			•	1	•	•	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \mu A$	-1.0	-1.9	-3.0	٧	
Gate-Body Leakage	I _{GSS}	V_{DS} = 0 V, V_{GS} = ± 20 V			± 100	nA	
Z-u- O-t- Velt Dusin Ourset	I _{DSS}	V _{DS} = -30 V, V _{GS} = 0 V			-1		
Zero Gate Voltage Drain Current		$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 70^{\circ}\text{C}$			-10	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = -5 \text{ V}, V_{GS} = -10 \text{ V}$	-30			Α	
Drain-Source On-State Resistance ^a	r _{DS(on)}	$V_{GS} = -10 \text{ V}, I_D = -11 \text{ A}$		0.010	0.014	Ω	
Drain-Source On-State Resistance		$V_{GS} = -4.5 \text{ V}, I_D = 8.5 \text{ A}$		0.017	0.023		
Forward Transconductancea	9fs	$V_{DS} = -15 \text{ V, } I_D = -11 \text{ A}$		23		S	
Diode Forward Voltage ^a	V _{SD}	$I_S = -2.7 \text{ A}, V_{GS} = 0 \text{ V}$		-0.75	-1.1	V	
Dynamic ^b							
Total Gate Charge	Qg			33	50	nC	
Gate-Source Charge	Q _{gs}	V_{DS} = -15 V, V_{GS} = -4.5 V, I_D = -11 A		10			
Gate-Drain Charge	Q _{gd}			13			
Turn-On Delay Time	t _{d(on)}			20	30	- ns	
Rise Time	t _r	V_{DD} = -15 V, R_L = 10 Ω		15	25		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong -1$ A, $V_{GEN} = -10$ V, $R_g = 6 \Omega$		95	150		
Fall Time	t _f			44	65		
Gate Resistance	R _g			3.2		Ω	
Source-Drain Reverse Recovery Time	t _{rr}	$I_F = -2.1 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$		50	80	ns	

- Notes
 a. Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2%.
 b. Guaranteed by design, not subject to production testing.

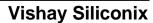
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)



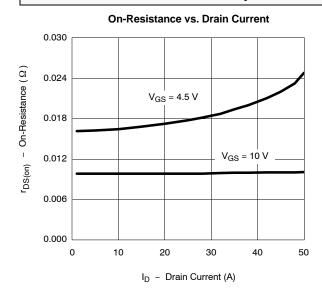


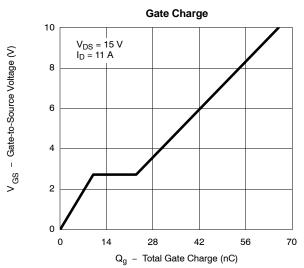


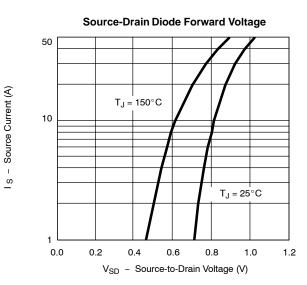


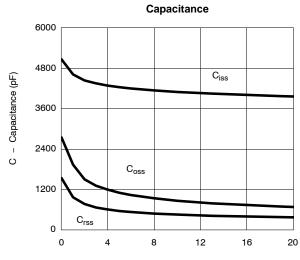


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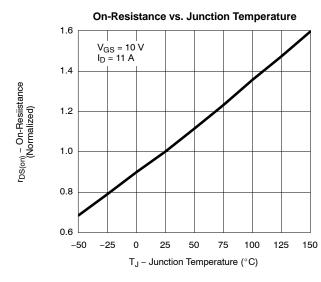


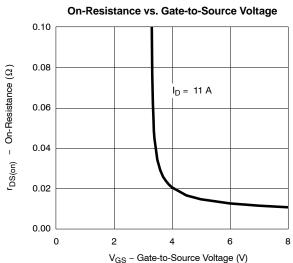






V_{DS} - Drain-to-Source Voltage (V)

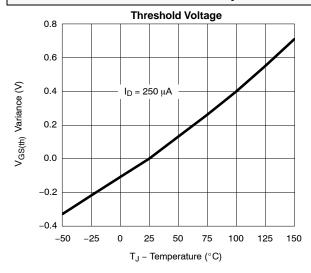


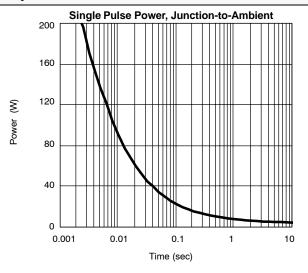


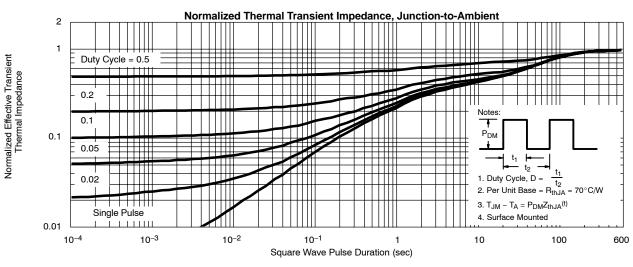
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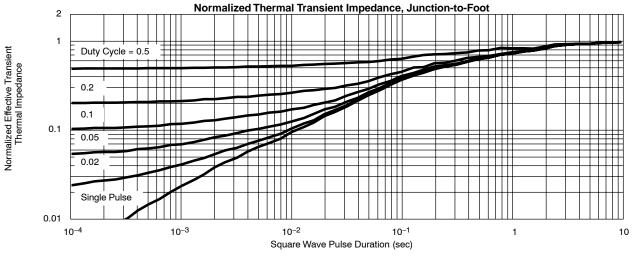


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Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?71817.



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